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A Microporous and Naturally Nanostructured Thermoelectric Metal–Organic Framework with Ultralow Thermal Conductivity

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Summary

Microporous metal–organic frameworks (MOFs) offer attributes that make them potentially compelling choices for thermoelectric applications because they combine organic character with long-range order and intrinsically low thermal conductivity. So far, thermoelectricity in this class of materials has required infiltration with external molecules to render the framework electrically conductive. Here, we present thermoelectric studies on an n-type naturally nanostructured microporous MOF, Ni₃(2,3,6,7,10,11-hexaiminotriphenylene)₂, whose pressed pellets exhibit high electrical conductivity and low thermal conductivity. The results here show that by combining the structural rigidity and high crystallinity of inorganic materials, the solution-based synthesis of organic materials, and the unique pore-based tunability and low thermal conductivity, MOFs represent an intriguing new class of thermoelectric materials.

**Keywords:** metal–organic framework, thermoelectrics, microporosity, nanostructuring, thermal insulator, electrical conductor
Introduction

Thermoelectric devices convert heat to electricity or vice versa, and are used to harness heat for power generation and for cooling applications.\(^1\) The power conversion efficiency of a thermoelectric material scales with a dimensionless figure of merit \(ZT = \sigma S^2T/\kappa\), where \(\sigma\) is the electrical conductivity, \(S\) the Seebeck coefficient, \(\kappa\) the thermal conductivity, and \(T\) the absolute temperature.\(^1\) Compelling enhancements in \(ZT\) have been achieved in recent years by exploiting nanostructuring and compositional engineering of inorganic materials,\(^2\)–\(^4\) as well as newly developed organic materials.\(^5\) However, inorganic materials often require rare, environmentally unfriendly elements, while organic materials suffer from low charge mobility due to the absence of long-range order. New materials that facilitate electrical conduction and suppress thermal conduction are needed for high-performance thermoelectrics.

Introducing porosity into materials is a useful strategy to improve their thermoelectric performance because pores can strongly scatter phonons.\(^6\) Importantly, porosity does not necessarily block charge transport. The continuous nonporous regions may still provide efficient charge transport pathways\(^7\) because the electron and phonon wavelengths are different.\(^2\) Therefore, porous solids could fit the requirements for an “electron-crystal phonon-glass”, the ideal material for thermoelectrics.\(^2\) An improved \(ZT\) is thus achievable when thermal conductivity is reduced to a larger extent than the power factor \((PF = \sigma S^2)\). Indeed, a few inorganic solids with randomly distributed macropores (pore diameter > 50 nm) and/or mesopores (pore diameter between 2 and 50 nm) exhibit significantly reduced thermal conductivity and comparable \(ZT\) with the values of their nonporous parent materials.\(^8\),\(^9\)

So far, little is known about the thermoelectric properties of periodic microporous materials mainly because it is technically challenging to generate such materials that exhibit significant electrical conductivity, especially by top-down methods such as lithography. In contrast, bottom-up, self-assembly strategies have generated a large number of microporous materials, among which MOFs are representative. These materials are constructed by bridging metal ions with organic ligands, and usually exhibit high porosity and surface area as well as long-range translational symmetry.\(^10\) The pores
are periodically distributed and exhibit diameters typically ranging from 0.5 nm to 3 nm, which can be tuned both chemically and physically by choosing organic ligands of different composition and length. For instance, choosing long and flexible organic ligands could provide large pores and enhance phonon scattering. Moreover, redox active metal ions and organic ligands could provide charge carriers. The use of abundant and nontoxic metal elements could improve scalability and safety.

Recent advances in understanding thermal and electrical conduction in MOFs reveal promising thermoelectric properties. Although reports of thermal conductivity in these materials are limited, materials in this class investigated thus far all exhibit \( \kappa < 0.4 \text{ W} \cdot \text{m}^{-1} \cdot \text{K}^{-1} \) regardless of structure, composition, or morphology, with the single-crystal thermal conductivity of MOF-5 being as low as 0.32 \( \text{W} \cdot \text{m}^{-1} \cdot \text{K}^{-1} \) at 27 °C. Despite their low thermal conductivity, MOFs have not been used extensively for thermoelectrics because they are typically electrical insulators. However, the last few years have seen significant advances in understanding and manipulating the electronic structure of these materials, with great improvements in electrical conductivity. Indeed, there are now several MOFs and structurally related coordination polymers that exhibit room-temperature \( \sigma > 1 \text{ S} \cdot \text{cm}^{-1} \). Even with low thermal conductivity, \( \sigma \) values lower than 1 \( \text{S} \cdot \text{cm}^{-1} \) typically greatly reduce ZT. This has been shown for instance, with 7,7,8,8-tetracyanoquinodimethane-infiltrated \( \text{Cu}_3(\text{benzene-1,3,5-tricarboxylate})_2 \) (\( \text{Cu}_3(\text{BTC})_2\)-TCNQ), whose electrical conductivity of \( 7 \times 10^{-2} \text{ S} \cdot \text{cm}^{-1} \) leads to a relatively low ZT of \( 7 \times 10^{-5} \) at 25 °C, still a record for MOFs, despite a low \( \kappa \) of 0.27 \( \text{W} \cdot \text{m}^{-1} \cdot \text{K}^{-1} \) and high Seebeck coefficient of 375 \( \mu \text{V} \cdot \text{K}^{-1} \).

Clearly, improving the electrical conductivity should have a positive effect on ZT. To this end, the material \( \text{Ni}_3(2,3,6,7,10,11\text{-hexaiminotriphenylene})_2 \) (\( \text{Ni}_3(\text{HITP})_2 \)) is an ideal case study. It features a layered two-dimensional lattice consisting of \( \text{Ni}^{2+} \) ions and HITP ligands arranged in a honeycomb structure. The layers are stacked, forming a graphite-like material with 1.5 nm-wide tubular pores running parallel to the \( c \) direction (Figure 1a). In agreement with the relatively big pore size, this material exhibits a high Brunauer–Emmett–Teller (BET) surface area of 630 \( \text{m}^2 \cdot \text{g}^{-1} \). More importantly, polycrystalline samples of \( \text{Ni}_3(\text{HITP})_2 \) exhibit high \( \sigma \) of approximately 50 \( \text{S} \cdot \text{cm}^{-1} \), among
the highest for polycrystalline MOFs. Herein, we show that this high electrical conductivity leads to a 17-fold improvement of the ZT value compared to Cu$_3$(BTC)$_2$-TCNQ, representing a significant step forward in improving the thermoelectric performance of MOFs.

**Results**

Bulk Ni$_3$(HITP)$_2$ was synthesized according to a previously published procedure. Its identity was confirmed by powder X-ray diffraction (Figure S1), and its porosity was verified by N$_2$ sorption analysis, which revealed a BET surface area of 766 m$^2$·g$^{-1}$ for the desolvated sample (additional details in Experimental Procedures, Figure S2). Transmission electron microscopy (TEM) provided additional insight into the bulk structure of Ni$_3$(HITP)$_2$ by revealing two distinct morphological components: films and nanoparticles. The films likely form at the interface between the reaction mixture and air, as has been reported for related 2D MOFs. The films appear extended, smooth, and folded in the TEM images, but do not diffract electrons, possibly because of electron beam damage (Figure S3a). Indeed, TEM imaging of MOFs is notoriously difficult: MOFs tend to decompose under high-energy electron beam. In contrast, the Ni$_3$(HITP)$_2$ nanoparticles appear crystalline (Figure S3b,S3c), with parallel 1D pores, 2D honeycomb lattices (Figure 1b) and stacks of multiple 2D sheets all clearly visible by TEM (Figure 1c). Fast Fourier transform (FFT) analysis from selected areas of the TEM micrographs, shown in Figure 1b,c, and S3d, revealed a hexagonal unit cell with cell parameters $a = b = 20.1$ Å, and $c = 6.6$ Å (Table S1). These are in agreement with the unit cell parameters obtained from the PXRD analysis and DFT calculations ($a = b = 21.8$ Å, $c = 6.7$ Å). The interlayer stacking of Ni$_3$(HITP)$_2$ is irregular, and the corresponding FFT image displays arcs instead of spots for the (002) diffraction (Figure 1c inset), again in line with the broad peak at $2\theta = 27.3^\circ$ in the PXRD pattern (Figure S1). Although the particle size varies widely, the largest Ni$_3$(HITP)$_2$ particles measure 20 nm $\times$ 20 nm $\times$ 50 nm, the latter dimension corresponding to approximately 150 stacked sheets.

Pressed pellets of Ni$_3$(HITP)$_2$ were prepared by pressing powder samples under 1 GPa at room temperature for 15 min with an uniaxial hydraulic press. The pellets are circular plates with a diameter of 6 mm and thickness ranging from 300 μm to 2 mm. The
PXRD pattern of the pressed pellets matched that of the powder (Figure S1), indicating that Ni$_3$(HITP)$_2$ retains its structure after pressure treatment at 1GPa. The density of the as-prepared pressed pellets was approximately 1.0 g·cm$^{-3}$, slightly smaller than the crystallographic density (1.15 g·cm$^{-3}$) calculated from the precise formula of Ni$_3$(HITP)$_2$: Ni$_3$(HITP)$_{1.8}$Cl$_{0.6}$·2(acetone)·4H$_2$O (see Experimental Procedures). This indicates the existence of grain boundaries and/or voids in the pressed pellets, as also verified by scanning electron microscopy (SEM, Figure 1d, S4). The nanoparticles were randomly oriented in the pressed pellets, such that the thermoelectric properties likely reflect averages of the intralayer and interlayer components. All thermoelectric characterizations were carried out between 25 and 45 °C. The electrical conductivity of the pellets was measured by the van der Pauw method.$^{35,36}$ The Seebeck coefficient and thermal conductivity were measured by the steady-state method using a home-built system that reaches high accuracy.$^{37-39}$ All thermoelectric properties were measured in vacuum (10$^{-5}$ to $10^{-4}$ torr) with the pressed pellets desolvated at 150 °C for 2 h.

As shown in Figure 2a, the electrical conductivity increased linearly with temperature from 58.8 S·cm$^{-1}$ at 25 °C to 62.1 S·cm$^{-1}$ at 45 °C. The pellets exhibited a negative room temperature Seebeck coefficient, $S = -11.9$ μV·K$^{-1}$, as shown in Figure 2b, indicative of n-type thermoelectric behavior.$^{40}$ $S$ is nearly constant over this temperature range and defines a power factor ranging from $8.31 \times 10^{-3}$ μW·cm$^{-1}$·K$^{-2}$ at 25 °C to $8.80 \times 10^{-3}$ μW·cm$^{-1}$·K$^{-2}$ at 45 °C (Figure S5). These values are at least one order of magnitude higher than those observed for Cu$_3$(BTC)$_2$-TCNQ.$^{18}$ Importantly, the pressed pellets of Ni$_3$(HITP)$_2$ exhibited very low thermal conductivity, $\kappa = 0.21$ W·m$^{-1}$·K$^{-1}$ (Figure 2c). This value is much lower than those of conventional solid-state thermoelectric materials such as nanostructured Bi$_x$Sb$_{2-x}$Te$_3$ ($\kappa_{\text{pellet}} \approx 1$ W·m$^{-1}$·K$^{-1}$ at room temperature)$^{41}$ and is comparable to the smallest values achieved for any thermoelectric materials.$^{5,42}$ As with $S$, $\kappa$ is relatively constant over 25–45 °C.

With the relevant values of $\sigma$, $\kappa$, and $S$, pellets of Ni$_3$(HITP)$_2$ exhibited a ZT of $1.19 \times 10^{-3}$ at 25 °C, which increased to $1.34 \times 10^{-3}$ at 45 °C (Figure 2d). These values are approximately 17 times higher than those observed for Cu$_3$(BTC)$_2$-TCNQ, the previous record for MOFs, and are directly attributable to the higher electrical conductivity of
Ni$_3$(HITP)$_2$.\textsuperscript{18} Although this thermoelectric figure of merit value is still much lower than those required for practical applications (ZT > 1), it represents a new benchmark for ZT values in MOFs.

**Discussion**

The most prominent feature of Ni$_3$(HITP)$_2$ is its ultralow thermal conductivity, among the lowest for any crystalline solid state material. In solids near room temperature, thermal conductivity can be divided into electronic ($\kappa_e$) and lattice ($\kappa_L$) contributions. The former is typically related to the electrical conductivity via the Wiedemann-Franz law, $\kappa_e = L\sigma T$, where the Lorenz number $L$ is usually taken to be $2.44 \times 10^{-8}$ W·Ω·K$^{-2}$.\textsuperscript{43} For Ni$_3$(HITP)$_2$, whose electrical conductivity at 25 °C is 58.8 S·cm$^{-1}$, $\kappa_e$ is $4.28 \times 10^{-3}$ W·m$^{-1}$·K$^{-1}$. This value is much smaller than the experimentally observed bulk thermal conductivity in Ni$_3$(HITP)$_2$, 0.21 W·m$^{-1}$·K$^{-1}$, suggesting that $\kappa_L$ dominates the overall thermal transport in our material.

Several factors may contribute to the low lattice thermal conductivity of Ni$_3$(HITP)$_2$. First, phonons describe lattice vibrations that carry thermal energy, which cannot propagate across the intrinsic vacant pores. Second, the heterogeneity of atomic masses and stiffness of bonds in Ni$_3$(HITP)$_2$ cause phonon scattering. Third, the disordered stacking of the individual Ni$_3$(HITP)$_2$ layers, observed by TEM (Figure 1c), may cause additional phonon scattering. Finally, given the very small particle size of the crystallites within the Ni$_3$(HITP)$_2$ pellets, grain boundaries play an important role in scattering phonons as well. Indeed, nanostructuring, or breaking large crystallites into nanoparticles, is a widely used strategy to reduce $\kappa_L$ in thermoelectric materials.\textsuperscript{44,45} However, generating nanostructured inorganic materials from bulk solids is challenging and energy consuming.\textsuperscript{2} In this aspect, Ni$_3$(HITP)$_2$ is advantageous because it is naturally nanostructured.

Among the factors described above, the first two are likely general for all microporous/mesoporous MOFs, whereas the last two are specific for Ni$_3$(HITP)$_2$ pellets. Although the inaccessibility to large single crystals of Ni$_3$(HITP)$_2$ makes measuring its intrinsic thermal conductivity impractical, literature precedent for MOFs suggests that
intrinsic factors are likely to dominate here too: as mentioned above, previously reported thermal conductivity values in MOFs are all smaller than 0.4 W·m·K⁻¹ at room temperature,¹²⁻¹⁸ with single-crystal values reaching 0.32 W·m·K⁻¹ (in MOF-5).¹² Indeed, MOFs with high porosity and complex composition are all likely to behave as thermal insulators, such that improving the electrical conductivity and the Seebeck coefficient should lead to high-performance thermoelectrics. Although certain principles for achieving high electrical conductivity in MOFs are now emerging,⁷ improvements in Seebeck coefficient require fine tuning of the band structure, a widely understudied concept in this class of materials.

In summary, Ni₃(HITP)₂ is the first example of an n-type thermoelectric MOF, and exhibits a record thermoelectric figure of merit for this class of materials, approximately 10⁻³. The ZT of Ni₃(HITP)₂ is mainly limited by the small absolute value of its Seebeck coefficient, itself the result of the possible metallic nature of Ni₃(HITP)₂, suggested theoretically by its band structure.⁴⁶ Improvements in thermopower could be achieved by controlling the chemical doping or through further optimization of the hierarchical structure. Indeed, our tentative measurements on thin films of Ni₃(HITP)₂ have revealed a Seebeck coefficient of approximately −50 μV·K⁻¹ at 25 °C, further confirming its n-type behavior, and highlighting the possibility to improve and tailor the thermoelectric properties through further processing.

Although these results describe a significant improvement in the ZT of MOFs specifically, the relatively low value in the context of the wider thermoelectrics field highlights the crucial need for additional systematic studies to further improve the thermoelectric performance of MOFs to meet the practical requirements. First, it is critical to achieve a high Seebeck coefficient because S influences ZT more significantly than other parameters (ZT ∝ S²). In this context, it would be initially productive to measure and tabulate the Seebeck coefficients of previously reported electrically conductive MOFs. This would enable a correlation between electrical conductivity and Seebeck coefficient in this class of materials. We also note that for traditional thermoelectric materials, the systematic variation of charge density serves as an important tool for optimizing the power factor. Here, we have not optimized the charge density, but
MOFs in general offer the opportunity for fine tuning of this parameter and therefore of
the power factor, especially when redox-active. Second, as we have noted elsewhere, there is a critical need for fundamental studies on the mechanism of charge transport in
MOFs based on accurate measurements of charge mobility and charge density. Third,
although these results point to an ultra-low thermal conductivity as a potentially general
feature of MOFs stemming from their periodic, porous, and compositionally complex
structures, it is of increasing interest to investigate the influence of metal ions, pore size,
structural rigidity, and the adsorbed guest molecules on thermal conductivity. Fourth,
computational studies on the electronic band structure and phonon dispersion relation of
microporous materials are helpful for understanding and optimizing their thermoelectric
properties. Materials with large density of states near the Fermi level are especially
attractive because they tend to exhibit large Seebeck coefficients. Finally, the
applicability of current thermoelectric characterization methods to MOFs should be verified and new characterization methods may be needed specifically for this class of materials. Beyond the exploration of MOFs as promising thermoelectric materials, these continued efforts will improve the understanding of the thermoelectric properties of microporous solids.

**Experimental Procedures**

**Materials**

NiCl₂·6H₂O (Fisher Scientific), aqueous ammonia (VWR), ethanol (VWR), isopropanol
(VWR), acetone (Sigma Aldrich), gold wires (25 μm diameter, Alfa Aesar), and carbon
paste (Electron Microscopy Sciences, graphite conductive adhesive 112) were purchased
from commercial sources and were used without purification. 2,3,6,7,10,11-
hexaaminotriphenylene hexahydrochloride, HATP·6HCl, was synthesized according to a
literature procedure.47

**Characterization of the powder of Ni₃(HITP)₂**

Ni₃(HITP)₂ was synthesized by modifying a published procedure, which generates a
material exhibiting a higher degree of crystallinity.24 A quantity of 95.7 mg of
NiCl₂·6H₂O and 141.9 mg of HATP·6HCl were dissolved in 60 mL of deionized (DI)
water in a 250 mL round-bottom flask. The resulting yellow solution was heated to 65 °C in an oil bath, and treated with 1.5 mL of concentrated aqueous ammonia. The reaction mixture was kept at 65 °C for 45 min under continuous air bubbling, upon which the reaction was switched to an inert atmosphere and kept at 65 °C for an additional 2 h. The resulting crude black precipitate was separated from the reaction mixture by centrifugation, was soaked in deionized water at room temperature then washed with water, ethanol, and acetone. Finally, the solid product was dried under a stream of nitrogen gas for 12 h. The product was kept in a nitrogen-filled glovebox. We found that soaking Ni$_3$(HITP)$_2$ in water under air at elevated temperature for a few hours or exposing it to air for several months significantly reduced its electrical conductivity.

Elemental analysis was performed by Complete Analysis Laboratories, Inc. in Parsippany, NJ, United States. C, H, N, and Cl elemental analysis calcd. for Ni$_3$(C$_{18}$H$_{12}$N$_6$)$_2$, 2(C$_3$H$_6$O)$_4$·4(H$_2$O): C, 48.66%; H, 4.42%; N, 15.96%; Cl, 2.25%. Found: C, 48.98%; H, 4.26%; N, 16.21%; Cl, 2.4%.

Powder X-ray diffraction patterns were recorded with a Bruker D8 Advance diffractometer equipped with a θ/2θ Bragg-Brentano geometry and nickel-filtered Cu Kα radiation (Kα$_1$ = 1.5406 Å, Kα$_2$ = 1.5444 Å, Kα$_1$/Kα$_2$ = 0.5). The tube voltage and current were 40 kV and 40 mA, respectively. Samples were prepared by placing thin layers of materials on a zero-background silicon crystal plate. The background was corrected by using the Bruker Diffrac.Suite EVA software.

A Micromeritics ASAP 2020 Surface Area and Porosity Analyzer was used to measure N$_2$ adsorption isotherms. An oven-dried sample tube equipped with a Transeal™ (Micromeritics) was evacuated and tared. The Ni$_3$(HITP)$_2$ sample was transferred to the sample tube, which was then capped by a TranSeal™. The sample was heated to 80 °C, and held at this temperature for 26 h. The evacuated sample tube was weighed and the sample mass was determined by subtracting the mass of the previously tared tube. An N$_2$ adsorption isotherm was measured using a liquid nitrogen bath (77 K). Ultra high purity grade (99.999% purity) N$_2$ and He, oil-free valves and gas regulators were used for all free space corrections and measurements.
Transmission electron microscopy was performed using a Titan 80/300 Environmental Transmission Electron Microscopy at the Center for Functional Nanomaterials, Brookhaven National Laboratory (Upton, NY, USA). The instrument is equipped with a post-specimen spherical aberration corrector which was tuned to a flat phase field of 20 mRad. Images were acquired using a Gatan K2-IS direct electron detector, in the Summit mode. Each image was acquired at an electron dose of 30-40 electrons/Å², as measured by the K2 detector. Images given are comprised of the sum of up to 20 individual images acquired at 0.2 secs per image, using the built-in drift correction in the Gatan software. The summation of shorter image acquisitions allowed us to determine if the threshold dose for sample damage had been reached, and the summation was truncated at a point before damage is evident. The instrument was operated at 300 kV, as experiments showed that damage accumulation rates were substantially more rapid at 80 kV, even at the same electron dose.

**Characterization of pressed pellets of Ni₃(HITP)₂**

Pressed pellets of Ni₃(HITP)₂ were prepared by placing powders of Ni₃(HITP)₂ into a 6 mm inner-diameter trapezoidal split sleeve pressing die (Across International) and pressing the die set by a hydraulic press (MTI corporation) with 3 tons of applied mass for 15 min. The applied pressure was approximately 1 GPa. The thickness of the pellet was measured by a micrometer (Mitutoyo) and varied between 300 μm and 2 mm. The pellet density was approximately 1 g·cm⁻³.

Scanning electron microscopy was conducted at the Harvard Center for Nanoscale Systems (Cambridge, MA, USA) on a Zeiss Ultra55 or a Zeiss Supra55VP field emission scanning electron microscope with an InLens detector and a beam voltage of 3 kV.

Electrical conductivity of pellets of Ni₃(HITP)₂ was measured by the van der Pauw method at 25, 30, 35, 40, and 45 °C. A pellet was placed onto a Si wafer coated with 300 nm SiO₂. Four gold wires were pasted onto the periphery of the pellet by carbon paste in a square configuration. The bare ends of these gold wires were pasted onto the SiO₂/Si wafer by carbon paste. The van der Pauw device was mounted onto the sample chuck of a 4-arm probe station (Janis Cryogenics ST-500) with a layer of thermal paste (DuPont Krytox) to enable efficient heat transfer between the device and the sample chuck.
Electrical contacts were made by touching carbon paste on the SiO$_2$/Si wafer with gold-plated tungsten probes, whose positions were controlled by micro-manipulators. The probe station chamber was evacuated to a pressure of 10$^{-5}$ torr. The Ni$_3$(HITP)$_2$ pellet was heated at 150 °C for 2 h for complete desolvation. It was then cooled down to 25 °C and was kept in the dark and under dynamic vacuum (10$^{-5}$ torr). The temperature of the pellet was balanced by a heater of the probe station chuck and liquid nitrogen, and was controlled by a temperature controller (Scientific Instrument model 9700). Electrical data were obtained with a Keithley 2450 sourcemeter. The sheet electrical conductance was extracted by the van der Pauw equation. The electrical conductivity was calculated by dividing the sheet electrical conductance by the thickness of the pellet. The error was estimated by considering the error of both sheet electrical conductance and thickness measurements.

The Seebeck coefficient and the thermal conductivity of the pellet were measured using a homebuilt steady-state measurement system. The pellet (diameter: 6 mm; thickness: 1.8 mm) was sandwiched between a hot junction heater assembly and a cold junction electrode. Silver paste was used to mount the sample to minimize the electrical and thermal contact resistance. The heater assembly consists of a thin film resistance temperature detector as the electrical heater, which was brazed into a small copper block of approximately the same cross-sectional shape and size as the sample. Also embedded in the hot junction assembly are the current and voltage wire leads and a K-type thermocouple. The cold junction consists of a temperature-controllable cold stage, made with a copper heat spreader on top of a thermoelectric cooler module. The whole assembly was in a copper radiation shield to minimize radiative heat loss. The Ni$_3$(HITP)$_2$ pellet was heated at 150 °C in vacuum for 2 h for complete desolvation. The measurement was carried out in a vacuum chamber at a pressure below 10$^{-4}$ mbar. After the electrical heater in the hot junction assembly was turned on, the whole system was allowed to reach a thermal steady state. The temperature difference and the generated thermal voltage were recorded at multiple values of input heater power, and the thermal conductivity and Seebeck coefficient were extracted as the slopes of power-temperature and voltage-temperature curves. The reported values are averages of
multiple sweeps of the input heater power, and the error bars represent standard deviations.

**Author Contributions**

L. S., B. L., M. D. A., G. C., F. L., and M.D. designed and initiated the research. L. S. and D. S. synthesized and characterized the powder of Ni$_3$(HITP)$_2$, made pressed pellets, performed SEM, and electrical conductivity measurements. B. L., D. K., and J. Z. performed steady-state thermal conductivity and Seebeck coefficient measurements. L. S., E. S., and D. Z. performed TEM imaging. V. S. and A. A. T. helped synthesize Ni$_3$(HITP)$_2$. Y. G. performed surface area measurements. L. S., F. L, and M. D. analyzed data. All authors participated in the discussion. L. S. drafted the manuscript, and F. L. and M. D. revised it. All authors commented on the manuscript.

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Supplemental Information

Supplemental Information includes 5 figures and 1 table and can be found with this article online.

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Figure 1. Structure of Ni$_3$(HITP)$_2$. a, A portion of the crystal structure of Ni$_3$(HITP)$_2$ showing multiple stacked 2D layers. Orange, green, grey, and white spheres represent Ni, N, C, and H atoms, respectively. b,c, TEM micrographs of Ni$_3$(HITP)$_2$ nanoparticles viewed along the pores and perpendicular to the pores, respectively. Insets: FFT of the TEM images. See also Figure S3 and Table S1. d, SEM micrograph of a Ni$_3$(HITP)$_2$ pellet showing complex morphology and grain boundaries. See also Figure S4.
Figure 2. Thermoelectric properties of Ni₃(HITP)₂. Variable temperature (a) electrical conductivity, (b) Seebeck coefficient, (c) thermal conductivity, and (d) thermoelectric figure of merit.